

Model 149

Stratum 3E, 9x14 mm OCXO

Features

- 10 to 50 MHz Frequency Range
- Compliant to Stratum 3E of GR-1244-CORE
- Surface Mount
- 3.3V or 5.0V operation
- Low Jitter/Phase Noise
- Tape and Reel Packaging

Applications

- Telecom Switching
- Wireless Communication
- Timing over Packet

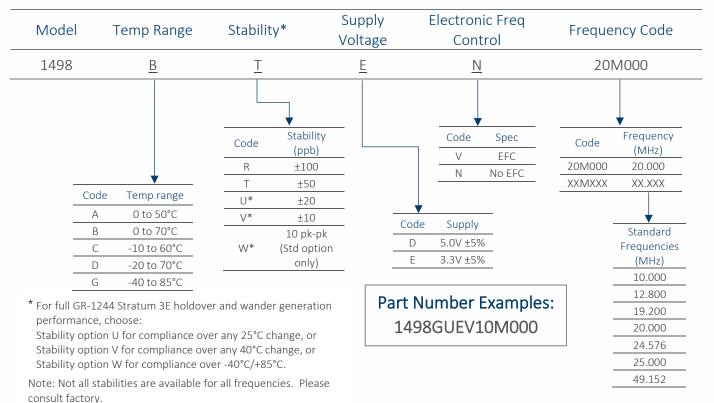


Part Dimensions: 9.7 × 14.9 x 7.0 mm

Description

The CTS Model 149 is a low cost, small size, high performance OCXO. The high quality SC Quartz Crystal used in this OCXO offers high stability and low jitter/phase noise, making it the ideal choice for any telecommunications system.

Ordering Information - Table 1



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Electrical Specifications

Parameter	Conditions & Remark	S	Min	Typical	Max	Unit
Operating Conditions						
Operating Temperature Range	Тор		-40	-	85	°C
Supply Voltage	V _{CC} : 3.3V or 5.0V		3.135 4.75	3.3 5.0	3.465 5.25	Vdc
Power Consumption	Warm-up Steady State; T _A = 25°C		-	- 0.7	2.7 1	W
Load			13.5	15	16.5	pF
Frequency Stability						
Frequency	Fnom		10	-	50	MHz
Initial Frequency Tolerance	@25°C, at time of shipme	nt	-	-	±0.200	ppm
Freq. vs Temperature (See Table 1)	-40°C to 85°C (ref to +25C 4°C change (option V)	.)	-	-	±10 1	ppb ppb pk-pk
Freq. vs Supply Voltage	Vcc ±5%		-	±1	±5	ppb
Freq. vs Load	15 pf ±5%		-	±1	±5	ppb
Freq. vs Time (Aging)	After 30 days of operation (for 19.2 MHz)	1	- - -	- - -	±1 ±100 ±0.5	ppb/day ppb/year ppm/10 yrs
Free run accuracy	All causes – 10 years		-	-	±1.6	ppm
Frequency Retrace	0.5 hours on after 24 hrs or preceded by 24 hrs on. Return off frequency.		-	-	±50	ppb
Short Term Stability (ADEV)	1.0 sec		-	-	0.05	ppb
Warm-up time	@ 25°C, After 5 mins referenced to the freq aft hour on	er 1	-	-	±50	ppb
Holdover Stability (24 hours)	For any 40°C change over the operating temperature range (Stability options U and V. See Table 1)		-	-	11	ppb, pk-pk
Wander Generation	Meets Strati	ım 3E MTI	E and TDE	/ per Telcordia	GR-1244-COF	RE
Output Parameters						
CMOS Output Levels	3.3V (LVCMOS) 5.0V (HCMOS)	VоL	- - 2.4 3.0	- - -	0.4 0.4 -	– Vdc
Rise/Fall Times	10% to 90%, 15pf load		-	-	5	ns
Duty Cycle	@50% of output signal		45	50	55	%



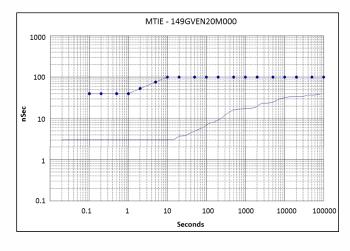
Electrical Specifications (Continued)

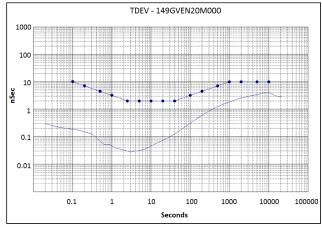
Parameter	Conditions & Remarks	Min	Typical	Max	Unit
	1 Hz	-	-85	-	
	10 Hz	-	-115	-	
Phase Noise	100 Hz	-	-138	-	dBc/Hz
(19.20 MHz)	1 kHz	-	-148	-	UBC/HZ
	10 kHz	-	-155	-	
	100 kHz	-	-158	-	

Electronic Frequency Control - EFC (Optional)

EFC Control Voltage	\/	3.3V	0.0	1.65	3.3	Volts
	Vc	5.0V	0.0	2.5	5.0	
Frequency Adjust Range			±0.8	-	±2.0	ppm
Slope	Positive, monotonic		-	-	-	
Input Impedance	Zin		100	-	-	Kohms
Linearity			-	-	10	%

Typical Stratum 3E Wander Generation performance per Telcordia GR-1244-CORE (locked through a 0.001Hz loop bandwidth)





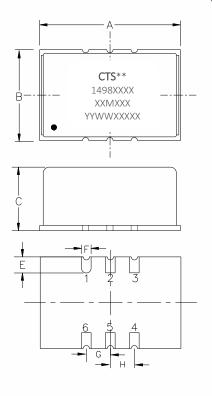


Mechanical and Environmental

Storage Temperature Range	-55°C to +105°C
Operating Temperature	
Range	-40°C to +85°C
Reflow Profile	Per IPC/JEDEC J-STD-020D; >217°C, 1.5min and 245°C (Absolute max temperature), 10 secs.
	Note: This product is not designed to be reflowed in an inverted position.
Mechanical Shock	500g, 1ms, 1/2 sinewave, 3 shocks each direction along 3 mutually perpendicular planes.
Drop	10 cm height, 3 times onto hard board with thickness of 3 cm IEC60028-2-32 test Ed.
Bumping	40g, 6mS, 4000 ±10 times in each of three mutually perpendicular axes
	40.5514.4.5
Mechanical Vibration	10-55 Hz, 1.5mm DA, 55-2000Hz 10G, 30 min sweep each axis
Thermal Shock	-40°C $^{\sim}$ +85°C. 0.5 hour dwells with <30 second transitions. 100 cycles
RoHS	Lead Free, and fully compliant to RoHS Directive 2011/65/EU
MSL	Level 2

Mechanical Specifications

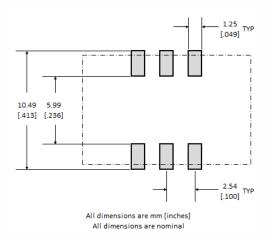
Pad termination finish: Gold flash < 10 μ inch, over Ni plated Cu



Dimension (mm)				
Symbol	Min	Max		
А	-	14.9		
В	-	9.7		
С	-	7.0		
Е	1.6	1.8		
F	0.9	1.1		
G	2.54 nominal			
Н	2.54 nominal			

Pad	Connection	
1	Vc or N/C	
2	N/C	
3	Ground	
4	Output	
5	N/C	
	Vcc	

Recommended Solder Pad



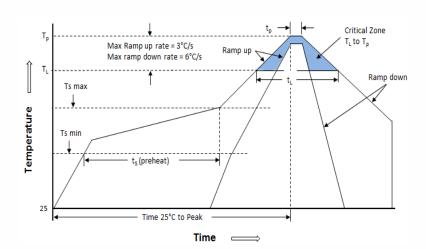
** Mfg site code

Serial Number

YYWWXXXXX (mfg date code = first 4 digits)



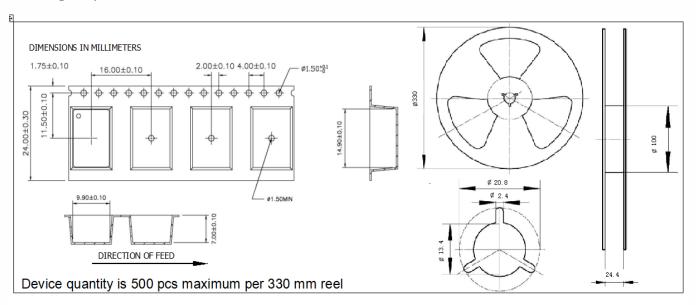
Solder Reflow



Ts max to TL(Ramp-up Rate)	3°C/s max
Preheat	
Temperature Min (Ts min)	150°C
Temperature typ (Ts)	175°C
Temperature max (Ts max)	200°C
Time (ts)	60-120 seconds
Ramp-up Rate (T _L to T _P)	3°C/s max
Time maintained above:	
Temperature (T _L)	217°C
Time (t _L)	90 seconds max
Dook Tomporature	245°C max for 10
Peak Temperature	seconds
Time within 5°C of peak (t _P)	20 seconds
Ramp-down Rate	6°C/s max
Time 25°C to Peak Temp (t)	8 minutes max

Note: Temperatures represent device body temperature.

Packing: Tape and Reel



This product is specified for use only in standard commercial applications. Supplier disclaims all express and implied warranties and liability in connection with any use of this product in any non-commercial applications or in any application that may expose the product to conditions that are outside of the tolerances provided in its specification.

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